



03C0#4

IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

PATENT APPLICATION

Applicant(s): **Kholodenko et al.**

Case: **4117/ETCH/CORETECH/JB1**

Serial No.: **09/663,864**

Filed: **September 15, 2000**

Group Art Unit: **Not yet assigned**

Title: **HIGH TEMPERATURE ELECTRICAL CONNECTOR**

THE COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D. C. 20231

S I R:

Disclosure Statement under 37 CFR 1.56 and 1.98

Pursuant to 37 CFR 1.56, the documents (copies enclosed) listed on form PTO-1449, submitted herewith, are disclosed. Under rule 37 C.F.R. 1.98(a), the applicants submit that no specific comments are necessary for any of the cited English language publications having an enclosed English language translation or abstract.

Respectfully submitted,

12/7/00
Date

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CERTIFICATE OF MAILING under 37 C.F.R. 1.8(a)

I hereby certify that this correspondence is being deposited on December 7, 2000 with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Michael Curo

Signature

12-7-00

Date of signature